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LIST OF PUBLICATIONS CITED BY APPLICATIONS	

Attorney Docket No.	Serial No.
SEL 308	10/098,688
<u>Applicant</u> Shunpei YAMAZAKI et al	
<u>Filing Date</u> March 15, 2002	<u>Group</u> 37 43 1767

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE

FOREIGN PATENT DOCUMENTS

, /	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
W.	JP 6-151414	05/31/94	Nippon Telegr. & Teleph.			11/02/92
	JP 10-055951 JP 2000- 105081	02/24/98 04/11/00	Sony Corp. Kanto Yakin Kogyo KK			08/12/96 09/25/98

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- 1) English abstract re Japanese Patent Application No. JP 6-151414 published May 31, 1994.
- 1) English abstract re Japanese Patent Application No. JP 10-055951 published February 24, 1998.
- 3) English abstract re Japanese Patent Application No. JP 2000-105081 published April 11, 2000.

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*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.

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APR 2 4 2003	5 30%		Attorney Docket No. SEL 308	
III .	97 PUBLICATIONS/MA TED BY APPLICAN		<u>Applicant</u> Yamazaki et al.	
			<u>Filing Date</u> March 15, 2002	Art Unit 1762
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*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME OF PA	FILING DATE
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	r	FOREIGN	PATENT DOCUMENTS	
	DOCUMENT NUMBER	DATE	NAME	ENG. ABSTRACT OR TRANSLATION
K	JP 2001- 267264	9/28/01	Horiuchi et al.	With, Eng. Abstract

OTHER PUBLICATIONS/MATERIALS (Including Author, Title, Date, Pertinent Pages)

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-:	6/24/03

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